1. Overview

ESP32 is a single 2.4 GHz Wi-Fi-and-Bluetooth combo chip designed with the TSMC ultra-low-power 40 nm technology. It is designed to achieve the best power and RF performance, showing robustness, versatility andreliability in a wide variety of applications and power scenarios.

The ESP32 series of chips includes ESP32-D0WDQ6, ESP32-D0WD, ESP32-D2WD, and ESP32-S0WD. For details on part numbers and ordering information, please refer to Part Number and Ordering Information.

1.1 Featured Solutions

1.1.1 Ultra-Low-Power Solution

ESP32 is designed for mobile, wearable electronics, and Internet-of-Things (IoT) applications. It features all the state-of-the-art characteristics of low-power chips, including fine-grained clock gating, multiple power modes, and dynamic power scaling. For instance, in a low-power IoT sensor hub application scenario, ESP32 is woken upperiodically and only when a specified condition is detected. Low-duty cycle is used to minimize the amount ofenergy that the chip expends. The output of the power amplifier is also adjustable, thus contributing to an optimaltrade-off between communication range, data rate and power consumption.

Note:
For more information, refer to Section 3.7 RTC and Low-Power Management.

1.1.2 Complete Integration Solution

ESP32 is a highly-integrated solution for Wi-Fi-and-Bluetooth IoT applications, with around 20 external com- ponents. ESP32 integrates an antenna switch, RF balun, power amplifier, low-noise receive amplifier, filters, and power management modules. As such, the entire solution occupies minimal Printed Circuit Board (PCB) area.

ESP32 uses CMOS for single-chip fully-integrated radio and baseband, while also integrating advanced calibration circuitries that allow the solution to remove external circuit imperfections or adjust to changes in external condi- tions. As such, the mass production of ESP32 solutions does not require expensive and specialized Wi-Fi testingequipment.

1.2 Wi-Fi Key Features

- 802.11 b/g/n
- 802.11 n (2.4 GHz), up to 150 Mbps
- WMM
- TX/RX A-MPDU, RX A-MSDU
- Immediate Block ACK

- Defragmentation
- Automatic Beacon monitoring (hardware TSF)
- 4 × virtual Wi-Fi interfaces

- Simultaneous support for Infrastructure Station, SoftAP, and Promiscuous modes
  Note that when ESP32 is in Station mode, performing a scan, the SoftAP channel will be changed.
- Antenna diversity

Note:
For more information, please refer to Section 3.5 Wi-Fi.

1.3 BT Key Features

- Compliant with Bluetooth v4.2 BR/EDR and BLE specifications
- Class-1, class-2 and class-3 transmitter without external power amplifier
- Enhanced Power Control
- +12 dBm transmitting power
- NZIF receiver with –97 dBm BLE sensitivity
- Adaptive Frequency Hopping (AFH)
- Standard HCI based on SDIO/SPI/UART
- High-speed UART HCI, up to 4 Mbps
- Bluetooth 4.2 BR/EDR BLE dual mode controller
- Synchronous Connection-Oriented/Extended (SCO/eSCO)
- CVSD and SBC for audio codec
- Bluetooth Piconet and Scatternet
- Multi-connections in Classic BT and BLE
- Simultaneous advertising and scanning

1.4 MCU and Advanced Features

1.4.1 CPU and Memory

- Xtensa® single-/dual-core 32-bit LX6 microprocessor(s), up to 600 MIPS (200 MIPS for ESP32-S0WD, 400MIPS for ESP32-D2WD)
- 448 KB ROM
- 520 KB SRAM
- 16 KB SRAM in RTC
- QSPI supports multiple flash/SRAM chips

1.4.2 Clocks and Timers

- Internal 8 MHz oscillator with calibration
- Internal RC oscillator with calibration
- External 2 MHz ~60 MHz crystal oscillator (40 MHz only for Wi-Fi/BT functionality)
- External 32 kHz crystal oscillator for RTC with calibration
- Two timer groups, including 2 × 64-bit timers and 1 × main watchdog in each group
- One RTC timer
- RTC watchdog

1.4.3 Advanced Peripheral Interfaces

- 34 × programmable GPIOs
- 12-bit SAR ADC up to 18 channels
- 2 × 8-bit DAC
- 10 × touch sensors
- 4 × SPI
- 2 × I^2S
- 2 × I^2C
- 3 × UART
- 1 host (SD/eMMC/SDIO)
- 1 slave (SDIO/SPI)
- Ethernet MAC interface with dedicated DMA and IEEE 1588 support
- CAN 2.0
- IR (TX/RX)
- Motor PWM
- LED PWM up to 16 channels
- Hall sensor

1.4.4 Security

- Secure boot
- Flash encryption
- 1024-bit OTP, up to 768-bit for customers
- Cryptographic hardware acceleration:
  - AES
  - Hash (SHA-2)

- RSA
- ECC

  - Random Number Generator (RNG)

1.5 Applications (A Non-exhaustive List)

- Generic Low-power IoT Sensor Hub
- Generic Low-power IoT Data Loggers
- Cameras for Video Streaming
- Over-the-top (OTT) Devices
- Speech Recognition
- Image Recognition
- Mesh Network
- Home Automation
  - Light control
  - Smart plugs
  - Smart door locks
- Smart Building
  - Smart lighting
  - Energy monitoring
- Industrial Automation
  - Industrial wireless control
  - Industrial robotics
- Smart Agriculture
  - Smart greenhouses
  - Smart irrigation
  - Agriculture robotics
- Audio Applications
  - Internet music players
  - Live streaming devices
  - Internet radio players
  - Audio headsets
- Health Care Applications
  - Health monitoring
  - Baby monitors
- Wi-Fi-enabled Toys
  - Remote control toys
  - Proximity sensing toys
  - Educational toys
- Wearable Electronics
  - Smart watches
  - Smart bracelets
- Retail & Catering Applications
  - POS machines
  - Service robots

1.6 Block Diagra

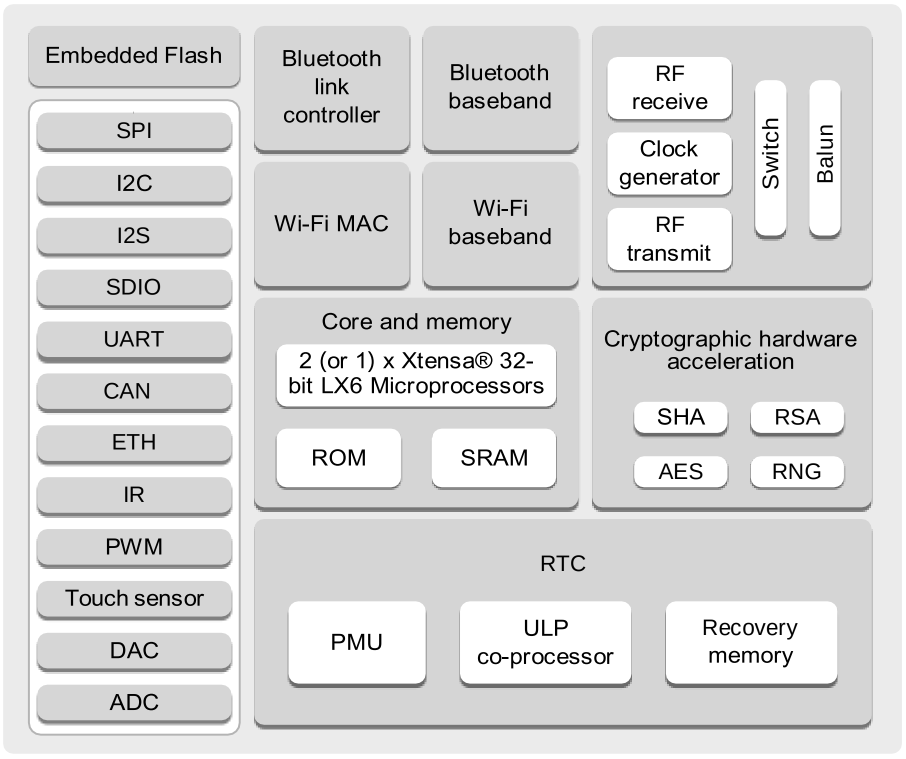

Figure 1: Functional Block Diagram

Note:
Products in the ESP32 series differ from each other in terms of their support for embedded flash and the number of CPUs they have. For details, please refer to Part Number and Ordering Information.

2. Pin Definitions

2.1 Pin Layout

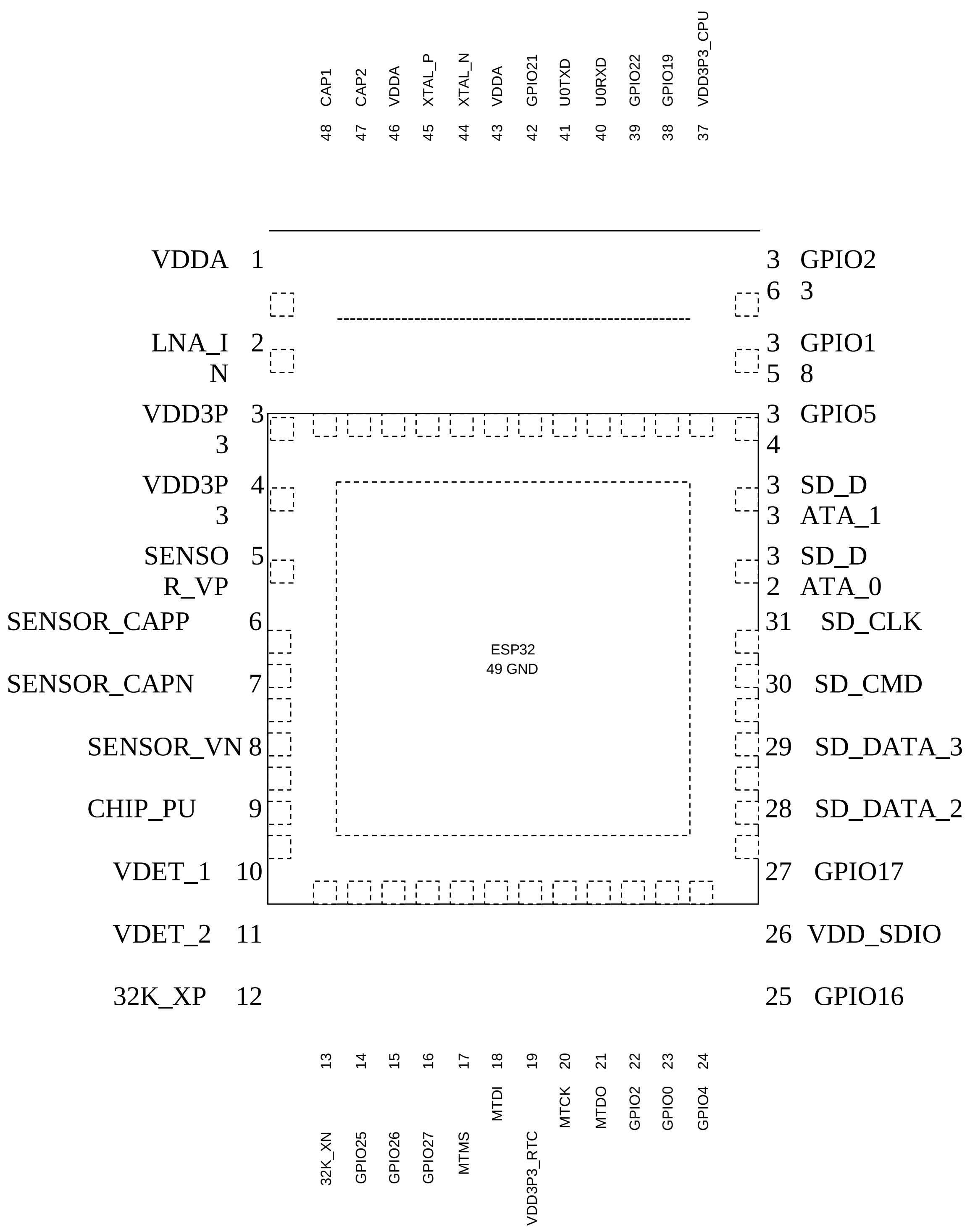

Figure 2: ESP32 Pin Layout (QFN 6*6, Top View)

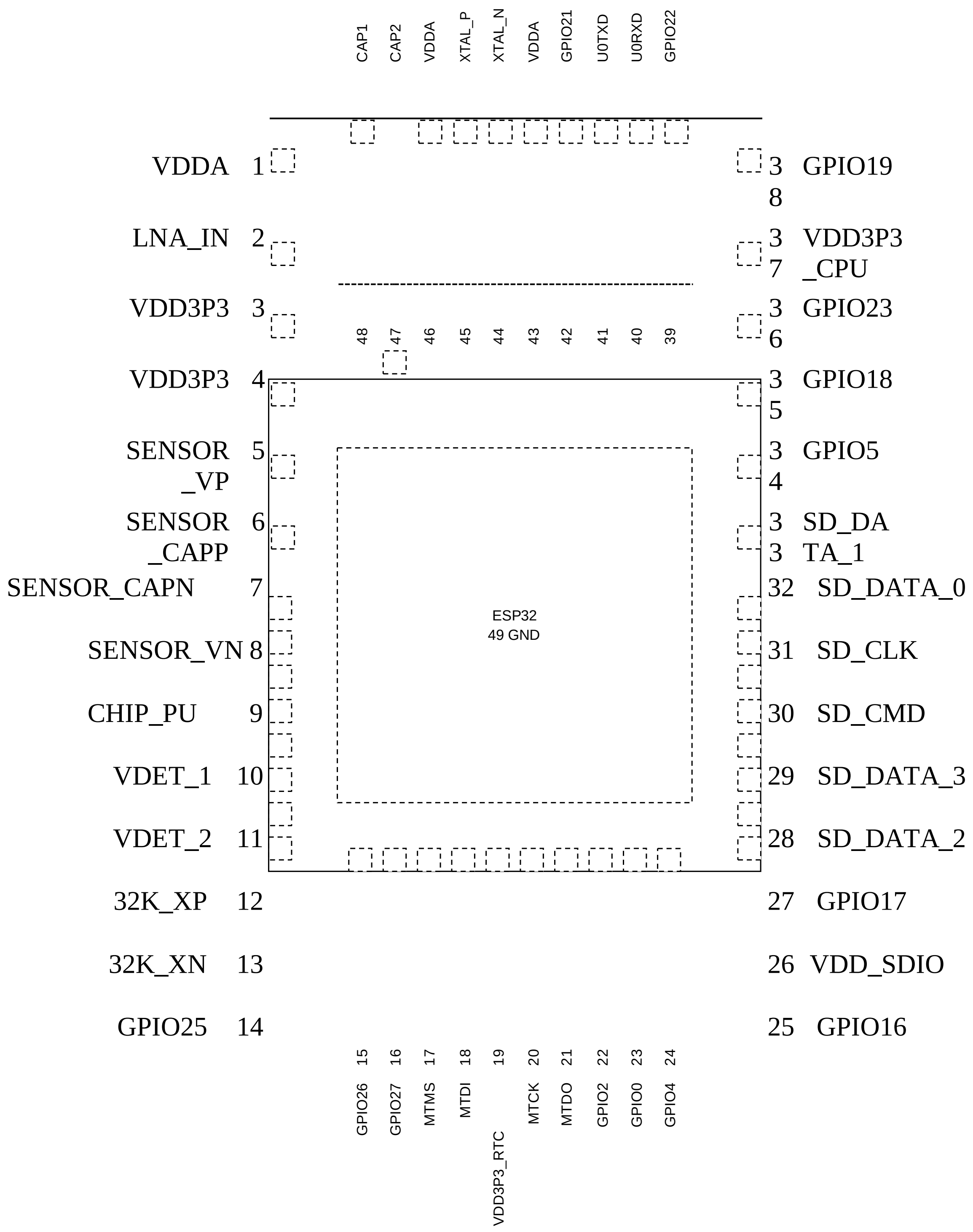

Figure 3: ESP32 Pin Layout (QFN 5*5, Top View)

Note:
For details on ESP32's part numbers and the corresponding packaging, please refer to Part Number and Ordering Information.

2.2 Pin Description

Table 1: Pin Description

Name	No.	Type	Function
			Analog
VDDA	1	P	Analog power supply (2.3 V – 3.6 V)
LNA_IN	2	I/O	RF input and output
VDD3P3	3	P	Analog power supply (2.3 V – 3.6 V)
VDD3P3	4	P	Analog power supply (2.3 V – 3.6 V)
			VDD3P3 _RTC
SENSOR_ VP	5	I	GPIO36, ADC1_CH0, RTC_GPIO0
SENSOR_ CAPP	6	I	GPIO37, ADC1_CH1, RTC_GPIO1
SENSOR_ CAPN	7	I	GPIO38, ADC1_CH2, RTC_GPIO2
SENSOR_ VN	8	I	GPIO39, ADC1_CH3, RTC_GPIO3
CHIP_PU	9	I	High: On; enables the chip Low: Off; the chip powers off Note: Do not leave the CHIP_PU pin floating.

Name	No.	Type	Function
VDET_1	10	I	GPIO34, ADC1_CH6, RTC_GPIO4
VDET_2	11	I	GPIO35, ADC1_CH7, RTC_GPIO5
32K_XP	12	I/O	GPIO32, ADC1_CH4, RTC_GPIO9, TOUCH9, 32K_XP (32.768 kHz crystal oscillator input)
32K_XN	13	I/O	GPIO33, ADC1_CH5, RTC_GPIO8, TOUCH8, 32K_XN (32.768 kHz crystal oscillator output)
GPIO25	14	I/O	GPIO25, ADC2_CH8, RTC_GPIO6, DAC_1, EMAC_RXD0
GPIO26	15	I/O	GPIO26, ADC2_CH9, RTC_GPIO7, DAC_2, EMAC_RXD1
GPIO27	16	I/O	GPIO27, ADC2_CH7, RTC_GPIO17, TOUCH7, EMAC_RX_DV
MTMS	17	I/O	GPIO14, ADC2_CH6, RTC_GPIO16, TOUCH6, EMAC_TXD2, HSPICLK, HS2_CLK, SD_CLK, MTMS
MTDI	18	I/O	GPIO12, ADC2_CH5, RTC_GPIO15, TOUCH5, EMAC_TXD3, HSPIQ, HS2_DATA2, SD_DATA2, MTDI
VDD3P3_RTC	19	P	Input power supply for RTC IO (2.3 V – 3.6 V)
MTCK	20	I/O	GPIO13, ADC2_CH4, RTC_GPIO14, TOUCH4, EMAC_RX_ER, HSPID, HS2_DATA3, SD_DATA3, MTCK
MTDO	21	I/O	GPIO15, ADC2_CH3, RTC_GPIO13, TOUCH3, EMAC_RXD3, HSPICS0, HS2_CMD, SD_CMD, MTDO
GPIO2	22	I/O	GPIO2, ADC2_CH2, RTC_GPIO12, TOUCH2, HSPIWP, HS2_DATA0, SD_DATA0
GPIO0	23	I/O	GPIO0, ADC2_CH1, RTC_GPIO11, TOUCH1, EMAC_TX_CLK, CLK_OUT1,
GPIO4	24	I/O	GPIO4, ADC2_CH0, RTC_GPIO10, TOUCH0, EMAC_TX_ER, HSPIHD, HS2_DATA1, SD_DATA1
VDD_SDIO			
GPIO16	25	I/O	GPIO16, HS1_DATA4, U2RXD, EMAC_CLK_OUT
VDD_SDIO	26	P	Output power supply: 1.8 V or the same voltage as VDD3P3_RTC
GPIO17	27	I/O	GPIO17, HS1_DATA5, U2TXD, EMAC_CLK_OUT_180
SD_DATA_2	28	I/O	GPIO9, HS1_DATA2, U1RXD, SD_DATA2, SPIHD
SD_DATA_3	29	I/O	GPIO10, HS1_DATA3, U1TXD, SD_DATA3, SPIWP
SD_CMD	30	I/O	GPIO11, HS1_CMD, U1RTS, SD_CMD, SPICS0
SD_CLK	31	I/O	GPIO6, HS1_CLK, U1CTS, SD_CLK, SPICLK
SD_DATA_0	32	I/O	GPIO7, HS1_DATA0, U2RTS, SD_DATA0, SPIQ
SD_DATA_1	33	I/O	GPIO8, HS1_DATA1, U2CTS, SD_DATA1, SPID

VDD3P3 _CPU			
GPIO5	34	I/O	GPIO5, HS1_DATA6, VSPICS0, EMAC_RX_CLK
GPIO18	35	I/O	GPIO18, HS1_DATA7, VSPICLK
GPIO23	36	I/O	GPIO23, HS1_STROBE, VSPID
VDD3P3_ CPU	37	P	Input power supply for CPU IO (1.8 V – 3.6 V)
GPIO19	38	I/O	GPIO19, U0CTS,VSPIQ, EMAC_TXD0
GPIO22	39	I/O	GPIO22, U0RTS,VSPIWP, EMAC_TXD1
U0RXD	40	I/O	GPIO3, U0RXD, CLK_OUT2
U0TXD	41	I/O	GPIO1, U0TXD, CLK_OUT3, EMAC_RXD2
GPIO21	42	I/O	GPIO21, VSPIHD, EMAC_TX_EN
Analog			
VDDA	43	P	Analog power supply (2.3 V – 3.6 V)
XTAL_N	44	O	External crystal output
XTAL_P	45	I	External crystal input
VDDA	46	P	Analog power supply (2.3 V – 3.6 V)
CAP2	47	I	Connects to a 3 nF capacitor and 20 kΩ resistor in parallel to CAP1
CAP1	48	I	Connects to a 10 nF series capacitor to ground
GND	49	P	Ground

Note:

- ESP32-D2WD's pins GPIO16, GPIO17, SD_CMD, SD_CLK, SD_DATA_0 and SD_DATA_1 are used for connecting the embedded flash, and are not recommended for other uses.
- For a quick reference guide to using the IO_MUX, Ethernet MAC, and GIPO Matrix pins of ESP32, please refer to Appendix ESP32 Pin Lists.
- In most cases, the data port connection between the ESP32 and external flash is as follows: SD_DATA0/SPIQ = IO1/DO, SD_DATA1/SPID = IO0/DI, SD_DATA2/SPIHD = IO3/HOLD#, SD_DATA3/SPIWP = IO2/WP#.

HC-SR04 Ultrasonic Sensor

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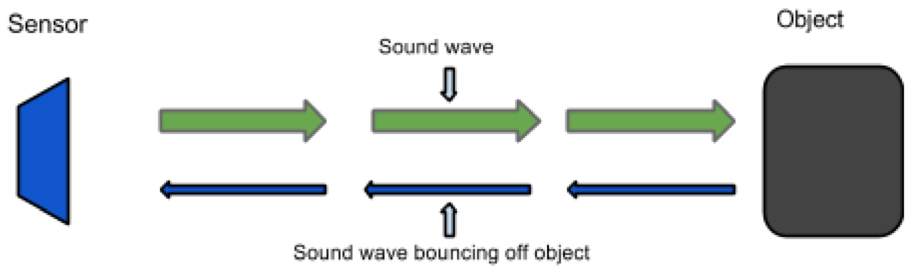
Morgan Nov.
16 2014

The purpose of this file is to explain how the HC-SR04 works. It will give a brief explanation of how ultrasonic sensors work in general. It will also explain how to wire the sensor up to a microcontroller and how to take/interpret readings. It will also discuss some sources of errors and bad readings.

1. How Ultrasonic Sensors Work

Ultrasonic sensors use sound to determine the distance between the sensor and the closest object in its path. How do ultrasonic sensors do this? Ultrasonic sensors are essentially sound sensors, but they operate at a frequency above human hearing.



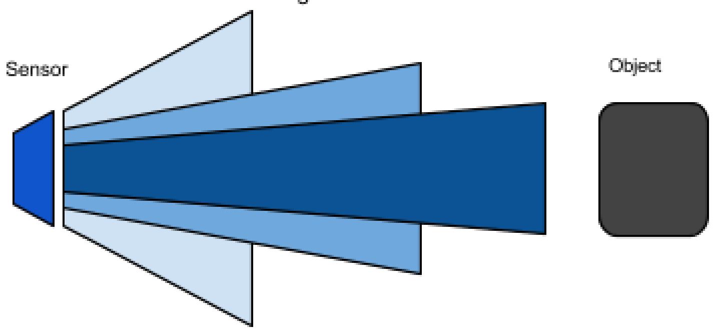
The sensor sends out a sound wave at a specific frequency. It then listens for that specific sound wave to bounce off of an object and come back (Figure 1). The sensor keeps track of the time between sending the sound wave and the sound wave returning. If you know how fast something is going and how long it is traveling you can find the distance traveled with equation 1.

Equation 1. $d = v \times t$

The speed of sound can be calculated based on the a variety of atmospheric conditions, including temperature, humidity and pressure. Actually calculating the distance will be shown later on in this document.

It should be noted that ultrasonic sensors have a cone of detection, the angle of this cone varies with distance, Figure 2 show this relation. The ability of a sensor to detect an object also depends on the objects orientation to the sensor. If an object doesn't present a flat surface to the sensor then it is possible the sound wave will bounce off the object in a way that it does not return to the sensor.

Figure 2



2. HC-SR04 Specifications

The sensor chosen for the Firefighting Drone Project was the HC-SR04. This section contains the specifications and why they are important to the sensor module. The sensor modules requirements are as follows.

- Cost
- Weight
- Community of hobbyists and support
- Accuracy of object detection
- Probability of working in a smoky environment
- Ease of use

The HC-SR04 Specifications are listed below. These specifications are from the Cytron Technologies HC-SR04 User's Manual (source 1).

- Power Supply: +5V DC
- Quiescent Current: <2mA
- Working current: 15mA
- Effectual Angle: <15º
- Ranging Distance: 2-400 cm
- Resolution: 0.3 cm
- Measuring Angle: 30º
- Trigger Input Pulse width: 10uS
- Dimension: 45mm x 20mm x 15mm
- Weight: approx. 10 g

The HC-SR04's best selling point is its price; it can be purchased at around $2 per unit.

3. Timing Chart and Pin Explanations

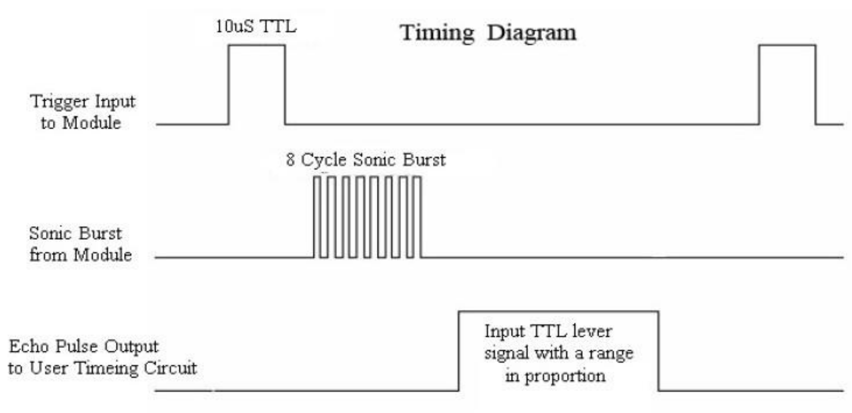
The HC-SR04 has four pins, VCC, GND, TRIG and ECHO; these pins all have different functions. The VCC and GND pins are the simplest -- they power the HC-SR04. These pins need to be attached to a +5 volt source and ground respectively. There is a single control pin: the TRIG pin. The TRIG pin is responsible for sending the ultrasonic burst. This pin should be set to HIGH for 10 μs, at which point the HC-SR04 will send out an eight cycle sonic burst at 40 kHZ. After a sonic burst has been sent the ECHO pin will go HIGH. The ECHO pin is the data pin -- it is used in taking distance measurements. After an ultrasonic burst is sent the pin will go HIGH, it will stay high until an ultrasonic burst is detected back, at which point it will go LOW.

Taking Distance Measurements

The HC-SR04 can be triggered to send out an ultrasonic burst by setting the TRIG pin to HIGH. Once the burst is sent the ECHO pin will automatically go HIGH. This pin will remain HIGH until the the burst hits the sensor again. You can calculate the distance to the object by keeping track of how long the ECHO pin stays HIGH. The time ECHO stays HIGH is the time the burst spent traveling. Using this measurement in equation 1 along with the speed of sound will yield the distance travelled. A summary of this is listed below, along with a visual representation in Figure 2.

1. Set TRIG to HIGH
2. Set a timer when ECHO goes to HIGH
3. Keep the timer running until ECHO goes to LOW
4. Save that time
5. Use equation 1 to determine the distance travelled

Figure 3
Source 2


10uS TTL
Timing Diagram
Trigger Input to Module
8 Cycle Sonic Burst
Sonic Burst from Module
Echo Pulse Output to User Timeing Circuit
Input TTL lever signal with a range in proportion

Source 2

To interpret the time reading into a distance you need to change equation 1. The clock on the device you are using will probably count in microseconds or smaller. To use equation 1 the speed of sound needs to determined,which is 343 meters per second at standard temperature and pressure. To convert this into more useful form use equation 2 to change from meters per second to microseconds per centimeter. Then equation 3 can be used to easily compute the distance in centimeters.

Equation 2.
$$\mathit{Distance} = \frac{\mathit{Speed}}{170.15\ m} \times \underline{\mu S}\ \frac{\mathit{Meters}}{100\ cm} \times \frac{1e6}{170.15\ m} \times \frac{58.772\ \mu S}{cm}$$

Equation 3.
$$\mathit{Distance} = \frac{\mathit{time}}{58} = \frac{\mu s}{\mu s/cm} = cm$$

4. Wiring the HC-SR04 to a Microcontroller

This section only covers the hardware side. For information on how to integrate the software side, look at one of the links below or look into the specific microcontroller you are using.

The HC-SR04 has 4 pins: VCC, GND, TRIG and ECHO.

1. VCC is a 5v power supply. This should come from the microcontroller
2. GND is a ground pin. Attach to ground on the microcontroller.
3. TRIG should be attached to a GPIO pin that can be set to HIGH
4. ECHO is a little more difficult. The HC-SR04 outputs 5v, which could destroy many microcontroller GPIO pins (the maximum allowed voltage varies). In order to step down the voltage use a single resistor or a voltage divider circuit. Once again this depends on the specific microcontroller you are using, you will need to find out its GPIO maximum voltage and make sure you are below that.

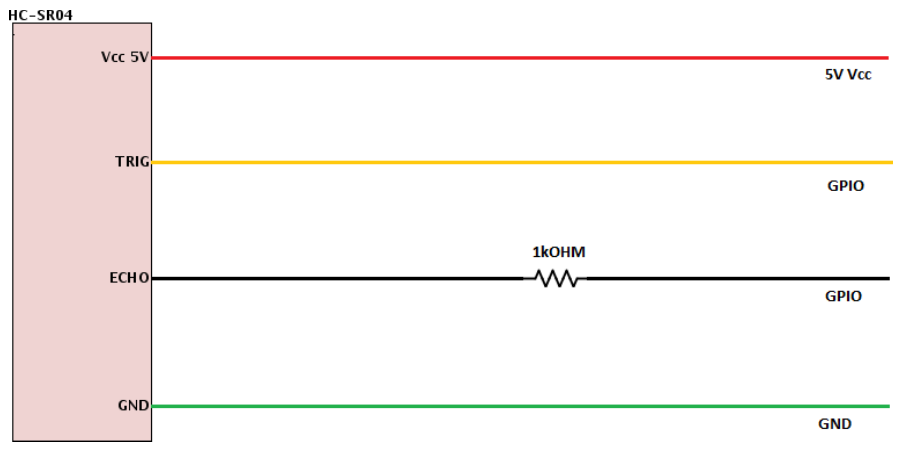
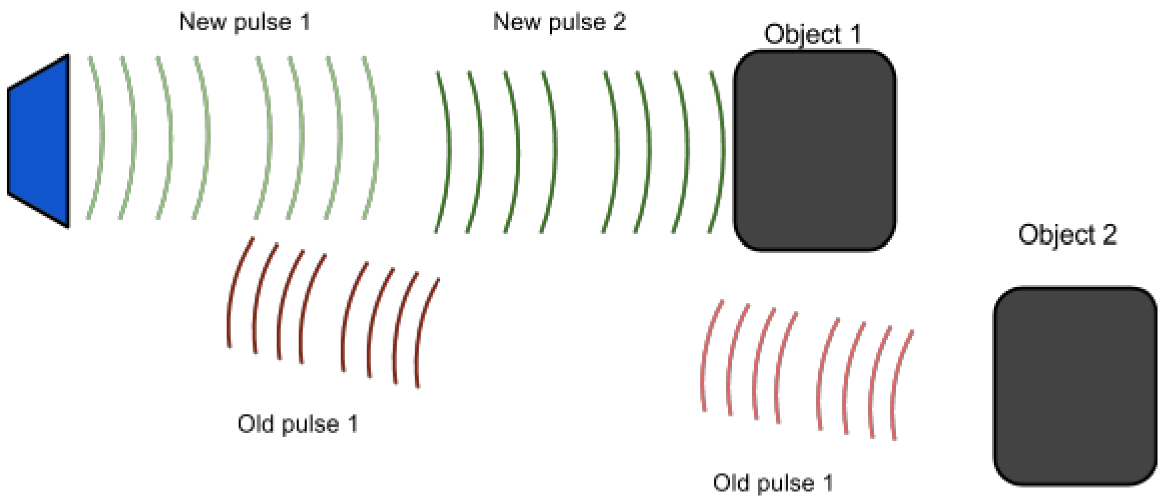


Figure 4

5. Errors and Bad Readings

Ultrasonic sensors are great sensors -- they work well for many applications where other types of sensors fall short. Unfortunately, they do have weaknesses. These weaknesses can be mitigated and worked around, but first they must be understood. The first weakness is that they use sound. There is a limit to how fast ultrasonic sensors can get distance measurements. The longer the distance, the slower they are at reporting the distance. The second weakness comes from the way sound bounces off of objects. In enclosed spaces it is possible, if not probable that there will be unintended echos. The echos can very easily cause false short readings. In Figure 2 a pulse was sent out. It bounced off of object 1 and returned to the sensor. The distance was recorded and then a new pulse was sent. There was another object farther away, so that when the new pulse reaches object 1, the first signal will reach the sensor. This will cause the sensor to think that there is an object closer than is actually true. The old pulse is smaller than the new pulse because it has grown weaker. The longer the pulse exists the weaker it grows until it is negligible. If multiple sensors are being used, the number of echos will increase along with the number of errors. There are two main ways to reduce the number of errors. The first is to provide shielding around the sensor. This prevents echos coming in from angle outside what the sensor should actually pick up. The second is to reduce the frequency at which pulses are sent out. This gives more time for the echos to dissipate.



Works Cited

Source 1.
"HC-SR04 User's_Manual." *docs.google.* Cytron Technologies, May 2013 Web. 5 Dec. 2009. <https://docs.google.com/document/d/1Y-yZnNhMYy7rwhAgyL_pfa39RsB-x2qR4vP8s aG73rE/edit>

Source 2.
"Attiny2313 Ultrasonic distance (HR-SR04) example." *CircuitDB*. n.a. 7 Sept. 2014 Web. 5 Dec. 2014. <http://www.circuitdb.com/?p=1162>

Links

These are not formatted; you will need to copy and paste them into your web browser.

Want to learn about Ultrasonic Sensors in general?
http://www.sensorsmag.com/sensors/acoustic-ultrasound/choosing-ultrasonic-sensor-prox imity-or-distance-measurement-825

All about the HC-SR04

- http://www.circuitdb.com/?p=1162
- http://www.micropik.com/PDF/HCSR04.pdf
- http://randomnerdtutorials.com/complete-guide-for-ultrasonic-sensor-hc-sr04/
- http://www.ezdenki.com/ultrasonic .php (^fantastic tutorial, explains a lot of stuff)
- http://www.elecrow.com/hcsr04-ultrasonic-ranging-sensor-p-316.html (^ this one has some cool charts)